# MN676011NPS

# NTSC Color Camera Synchronizing Signal Generator LSI

#### Overview

The MN676011NPS is a CMOS LSI that generates NTSC color camera synchronizing signals as defined by the EIA RS-170A standard.

It features a built-in  $4f_{SC}$  (14.31818 MHz) crystal oscillator circuit and divides that frequency to generate the horizontal synchronizing signal  $f_H$  (15.7 kHz), the vertical synchronizing signal  $f_V$  (60 Hz), and the composite synchronizing signal.

It also divides the 4f<sub>SC</sub> clock signal frequency by four to generate the color subcarrier frequency signals SC1 and SC2 and the burst signal gated with the burst flag (BF) pulse.

It includes a vertical reset (VR) input pin for resetting the leading edge of the vertical synchronizing pulse (VP) with the falling edge of the input signal. It also includes separate clock input pins for the color subcarrier frequency signal circuits and the synchronizing signal circuits to permit synchronization with such external synchronizing LSIs as the MN6761S.

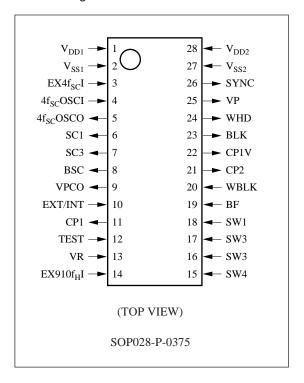
#### Features

- Power-saving CMOS synchronizing signal generator (conformed to EIA RS-170A standard)
- Built-in 14.31818 MHz clock generator
- 12 signal outputs including horizontal and vertical synchronizing signals and color subcarrier frequency signals (The vertical synchronizing signal is available as the VP signal output.)
- Pins for switching BLK signal pulse widths

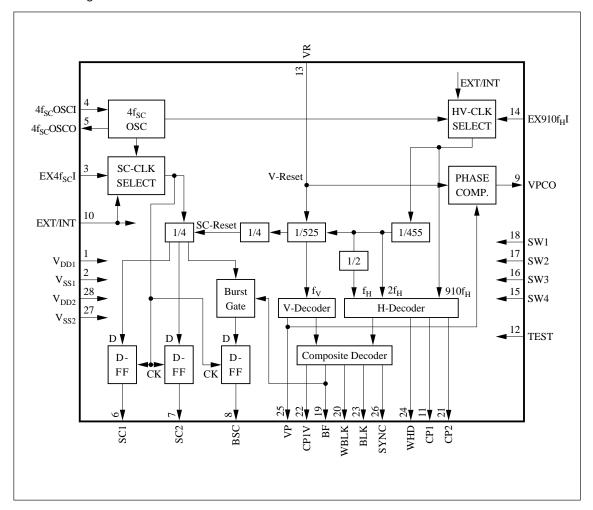
#### Applications

• Color video cameras

#### ■ Pin Assignment



### ■ Block Diagram



### ■ Pin Descriptions

Pin No.	Symbol	Pin Name	Function Description
1	$V_{\mathrm{DD1}}$	Power supply	"H" level power supply (Connect this pin to $+5.0 \pm 0.5 \text{ V.}$ )
			Power supply for color subcarrier frequency signal circuits
2	V <sub>SS1</sub>	Power supply	"L" level power supply (Connect this pin to 0 V.)
			Power supply for color subcarrier frequency signal circuits
28	$V_{\mathrm{DD2}}$	Power supply	"H" level power supply (Connect this pin to $+5.0 \pm 0.5 \text{ V.}$ )
			Power supply for horizontal and vertical synchronizing
			signals
27	V <sub>SS2</sub>	Power supply	"L" level power supply (Connect this pin to 0 V.)
			Power supply for horizontal and vertical synchronizing
			signals

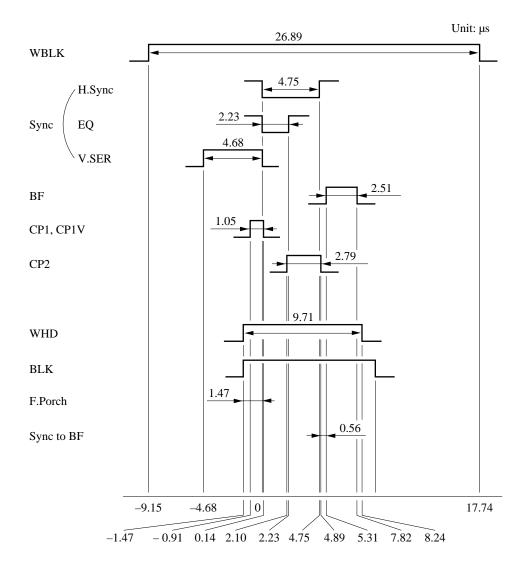
## ■ Pin Descriptions (continued)

Pin No.	Symbol	Pin Name		Function Do	escription	
4	4f <sub>SC</sub> OSCI	Crystal oscillator	Connect these pins to a 14.31818-MHz crystal oscil		18-MHz crystal oscilla	itor
		input	through capacito	rs appropriate	for V <sub>SS1</sub> .	
5	4f <sub>SC</sub> OSCO	Crystal oscillator	"L" level input to	the EXT/IN	Γ pin (which includes a	built-
3	41 <sub>SC</sub> USCU	-	in feedback resis	stor) produces	oscillation; "H" level i	nput
		output	stops it.			
3	EX4f <sub>SC</sub> I	External clock input	Color subcarrier frequency (4f <sub>SC</sub> ) input			
			"H" level input t	o the EXT/IN	T pin enables external	clock
			input. If this pin	is not used, ke	eep it at "L" level.	
14	EX910f <sub>H</sub> I External clock input External 910f <sub>H</sub> (14.31818		14.31818 MH	MHz) input for horizontal and		
			vertical synchron	nizing signals		
			"H" level input t	o the EXT/IN	T pin enables external	clock
			input. If this pin	is not used, ke	eep it at "L" level.	
10	EXT/INT	External/internal	This pin switche	s the chip bety	ween external and inter	nal
		synchronization switch	synchronization	modes.		
		input	"H" level input p	oroduces exter	nal synchronization;	
			"L" level, interna	al synchroniza	tion.	
	Incorporating		Incorporating pu	ll-down resist	or.	
13	VR	Vertical reset input	Falling edge inp	ut resets the le	ading edge of the verti	cal
			synchronizing si	gnal (VP).		
			The pin includes	a built-in pul	l-up resistor.	
12	TEST	Test input	Test input Keep this pin at "H" level.			
			The pin includes	a built-in pul	l-up resistor.	
9	VPCO	Phase comparator	This pin gives the results of comparing the phases		omparing the phases of	the
		output	falling edge of the	ne VR input ar	nd rising edge of the V	P
			output.			
			The output is at "H" level when the VR leads the VP and is		and is	
			at "L" level when the VR trails the VP.			
18	SW1					
			These pins contr	ol the widths	of H-BLK and V-BLK	pulses.
						_
		H-BLK pulse width	SW1	SW2	H-BLK (μs)	_
17	SW2	selection	L	L	10.69	
			Н	L	10.82	
			L	Н	10.97	
			H	Н	11.10	_
16	SW3					
			SW3	SW4	V-BLK (H)	-
		W.D.W. 1	L	L	19	-
		V-BLK pulse width	Н	L	20	
15	SW4	selection	L	H	21	
			Н	Н	21	
				11	21	-

# ■ Pin Descriptions (continued)

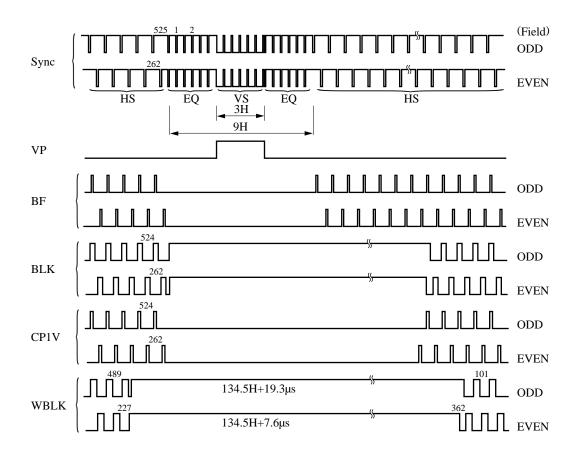
Pin No.	Symbol	Pin Name	Function Description
6	SC1	f <sub>SC</sub> (R-Y) output	Color subcarrier frequency signal (3.58 MHz) formed by
			dividing the crystal oscillator signal (4f <sub>SC</sub> ) by four.
7	SC2	f <sub>SC</sub> (B-Y) output	Color subcarrier frequency signal (3.58 MHz) formed by
			dividing the crystal oscillator signal (4f <sub>SC</sub> ) by four.
			This signal lags SC1 by 90°.
8	BSC	Burst output	Burst output signal
			If SC1 is the 180° signal, BSC is the 0° signal.
26	SYNC	Composite synchronizing	Composite synchronizing signal
		signal output	
25	VP	Vertical synchronizing	Vertical synchronizing signal output (width: 3H)
		signal output	
24	WHD	Wide HD output	Wide HD signal
			Preblanking signal with pulse width of 9.71 μs
23	BLK	Composite blanking	Composite blanking signal
		signal output	See the entries for SW1–SW4 for the pulse width.
22	CP1V	Composite clamp pulse	Composite pulse for black level playback
		output	
21	CP2	Clamp pulse output	Clamp pulses for luminance and color difference signals
			Horizontal deflection start pulses
20	WBLK	Composite wide	Composite wide blanking signal
		blanking output	This signal provides a horizontal blanking interval of
			26.89 µs and a vertical blanking interval of 134.5H
19	BF	Burst flag output	Gate signal for color subcarrier frequencies
			The pulse width is 2.51 µs with the vertical interval (9H)
			dropped out.
11	CP1	Clamp pulse output	Pulse for black level playback

## ■ H Decoder Pulse Timing Diagram



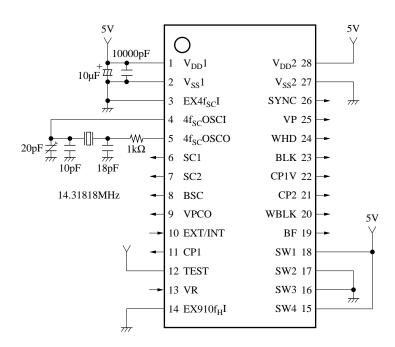
SW1	SW2	H-BLK (µs)
L	L	10.69
Н	L	10.82
L	Н	10.97
Н	Н	11.10

■ Pulse Timing Diagram for Composite and Vertical Synchronizing Signals



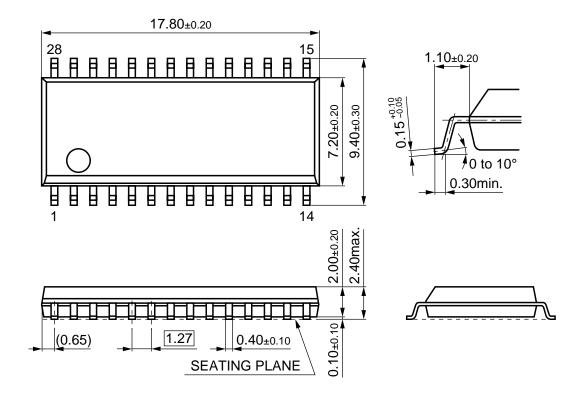
SW3	SW4	V-BLK (H)
L	L	19
Н	L	20
L	Н	21
Н	Н	21

## ■ Application Circuit Example



## ■ Package Dimensions (Unit: mm)

SOP028-P-0375



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